RENESAS

R1LV5256E Series

256Kb Advanced LPSRAM (32k word x 8bit)

R10DS0269EJ0200 Rev.2.00 2019.10.29

Description

The R1LV5256E Series is a family of low voltage 256-Kbit static RAMs organized as 32,768-word by 8-bit, fabricated by Renesas's high-performance 0.15um CMOS and TFT technologies. The R1LV5256E Series has realized higher density, higher performance and low power consumption. The R1LV5256E Series is suitable for memory applications where a simple interfacing, battery operating and battery backup are the important design objectives. It has been packaged in 28-pin SOP and 28-pin TSOP.

Features

- Single 2.7V~3.6V power supply
- Small stand-by current: 0.6µA (3.0V, typical)
- No clocks, No refresh
- All inputs and outputs are TTL compatible.
- Easy memory expansion by CS#
- Common Data I/O
- Three-state outputs: OR-tie Capability
- OE# prevents data contention on the I/O bus

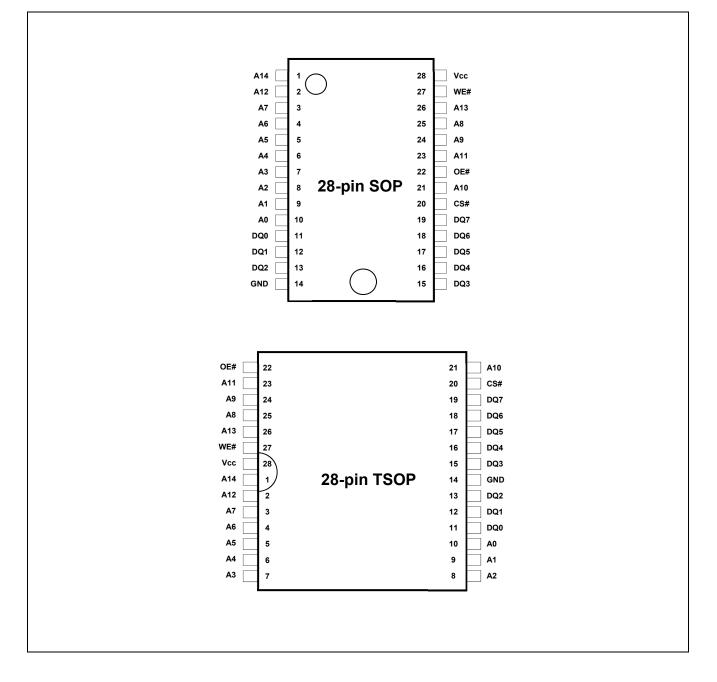
Ordering Information

Orderable part name	Access time	Temperature range	Package	Shipping container
R1LV5256ESP-5SI#B*			450-mil 28-pin	Tube (Magazine)
R1LV5256ESP-5SI#S*	55	10 0500	plastic SOP	Embossed tape
R1LV5256ESA-5SI#B*	55 ns	-40 ~ +85°C	8mm×13.4mm 28-pin	Tray
R1LV5256ESA-5SI#S*			plastic TSOP	Embossed tape

Note 1. * = Revision code for Assembly site change, etc. (* = 0, 1, etc.)



Pin Arrangement

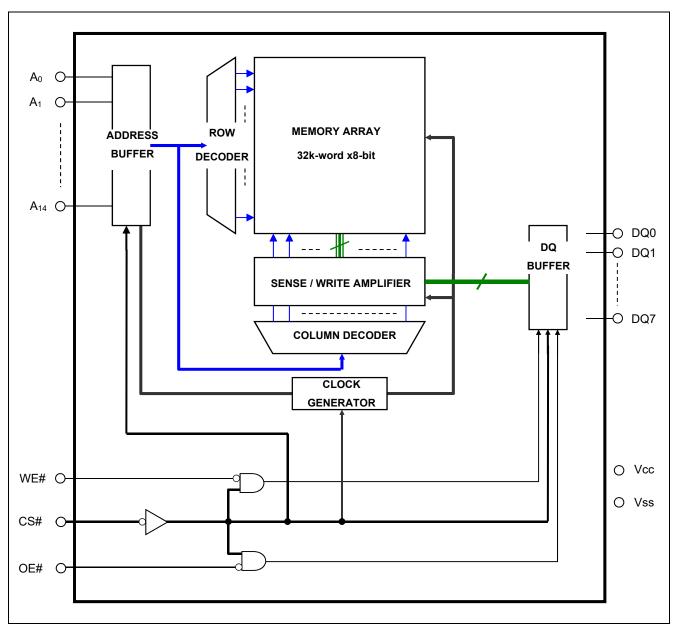


Pin Description

Pin name	Function
Vcc	Power supply
Vss (GND)	Ground
A0 to A14	Address input
DQ0 to DQ7	Data input/output
CS#	Chip select
WE#	Write enable
OE#	Output enable



Block Diagram





Operation Table

I	CS#	WE#	OE#	DQ0~7	Operation
	Н	Х	Х	High-Z	Stand-by
	L	L	Х	Din	Write
	L	Н	L	Dout	Read
	L	Н	Н	High-Z	Output disable

Note 1. H: V_{IH} L:V_{IL} X: V_{IH} or V_{IL}

Absolute Maximum

Parameter	Symbol	Value	unit
Power supply voltage relative to Vss	Vcc	-0.3 to +4.6	V
Terminal voltage on any pin relative to Vss	VT	-0.3 ^{*1} to Vcc+0.3 ^{*2}	V
Power dissipation	Pτ	0.7	W
Operation temperature	Topr	-40 to +85	°C
Storage temperature range	Tstg	-65 to 150	°C
Storage temperature range under bias	Tbias	-40 to +85	°C

Note 1. -3.0V for pulse ≤ 30 ns (full width at half maximum)

2. Maximum voltage is +4.6V.



DC Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage	Vcc	2.7	3.0	3.6	V	
	Vss	0	0	0	V	
Input high voltage	VIH	2.0	-	Vcc+0.3	V	
Input low voltage	VIL	-0.3	-	0.6	V	1
Ambient temperature range	Та	-40	-	+85	°C	

Note 1. -3.0V for pulse ≤ 30 ns (full width at half maximum)

DC Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit		Test conditions	
Input leakage current	ப	-	-	1	μA	Vin = Vss to Vcc		
Output leakage current	Ilo	-	-	1	μA	CS# =V _{IH} or OE# =V _{IH} , VI/O =Vss to Vcc		
Average operating current	Icc1	-	14	25	mA	-	duty =100%, II/O = 0mA, Others = V _{IH} /V _{IL}	
	Icc2	-	2	5	mA	Cycle =1µs, duty =100%, II/O = 0mA, CS# ≤ 0.2V, V _{IH} ≥ Vcc-0.2V, V _{IL} ≤ 0.2V		
Standby current	Isb	-	-	0.33	mA	CS# =V _{IH} , Others = Vss to Vcc		
Standby current		-	0.6 ^{*1}	2	μA	~+25°C	Vin = Vss to Vcc, CS# ≥ Vcc-0.2V	
	I _{SB1}	-	-	3	μA	~+40°C	-	
	1581	-	-	8	μA	~+70°C	-	
		-	-	10	μA	~+85°C		
Output high voltage	Vон	2.4	-	-	V	I _{OH} = -0.5m	A	
	Voh2	Vcc - 0.5	-	-	V	I _{OH} = -0.05mA		
Output low voltage	Vol	-	-	0.4	V	lo∟ = 1mA		

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

Capacitance

			(Vcc =	2.7V ~ 3	3.6V, f :	= 1MHz, Ta = -4	40 ~ +85°C)
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	Note
Input capacitance	C in	-	-	6	pF	Vin =0V	1
Input / output capacitance	C 1/0	-	-	8	pF	VI/O =0V	1

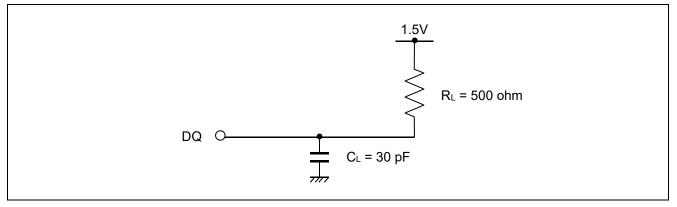
Note 1. This parameter is sampled and not 100% tested.



AC Characteristics

Test Conditions (Vcc = $2.7V \sim 3.6V$, Ta = $-40 \sim +85^{\circ}C$)

- Input pulse levels: VIL = 0.4V, VIH = 2.4V
- Input rise and fall time: 5ns
- Input and output timing reference level: 1.5V
- Output load: See figures (Including scope and jig)





Read Cycle

Parameter	Symbol	Min.	Max.	Unit	Note
Read cycle time	t _{RC}	55	-	ns	
Address access time	t _{AA}	-	55	ns	
Chip select access time	t _{ACS}	-	55	ns	
Output enable to output valid	toe	-	30	ns	
Output hold from address change	tон	10	-	ns	
Chip select to output in low-Z	tcLz	5	-	ns	2,3
Output enable to output in low-Z	t _{OLZ}	5	-	ns	2,3
Chip deselect to output in high-Z	tснz	0	20	ns	1,2,3
Output disable to output in high-Z	t _{онz}	0	20	ns	1,2,3

Write Cycle

Parameter	Symbol	Min.	Max.	Unit	Note
Write cycle time	twc	55	-	ns	
Address valid to end of write	taw	50	-	ns	
Chip select to end of write	tcw	50	-	ns	5
Write pulse width	twp	40	-	ns	4
Address setup time	t _{AS}	0	-	ns	6
Write recovery time	twR	0	-	ns	7
Data to write time overlap	t _{DW}	25	-	ns	
Data hold from write time	t _{DH}	0	-	ns	
Output enable from end of write	tow	5	-	ns	2
Output disable to output in high-Z	tонz	0	20	ns	1,2
Write to output in high-Z	twнz	0	20	ns	1,2

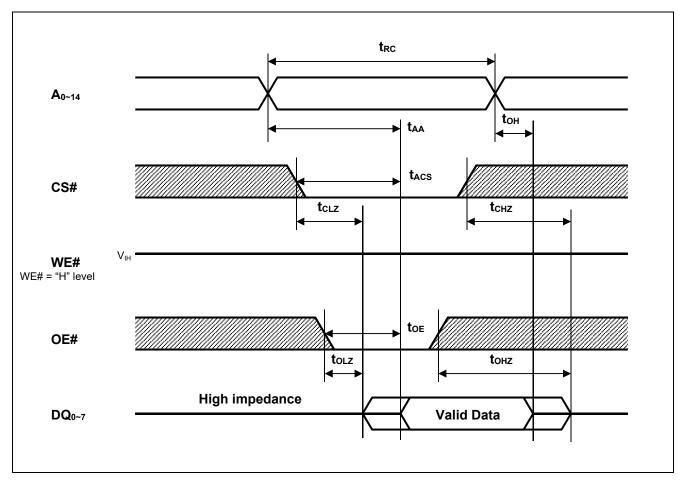
Note 1. t_{CHZ}, t_{OHZ} and t_{WHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.

- 2. This parameter is sampled and not 100% tested.
- 3. At any given temperature and voltage condition, t_{HZ} max is less than t_{LZ} min both for a given device and from device to device.
- 4. A write occurs during the overlap of a low CS#, a low WE#.
 A write begins at the latest transition among CS# going low and WE# going low.
 A write ends at the earliest transition among CS# going high and WE# going high.
 t_{WP} is measured from the beginning of write to the end of write.
- 5. t_{CW} is measured from the later of CS# going low to end of write.
- 6. t_{AS} is measured the address valid to the beginning of write.
- 7. twR is measured from the earliest of CS# or WE# going high to the end of write cycle.
- 8. Don't apply inverted phase signal externally when DQ pin is output mode.



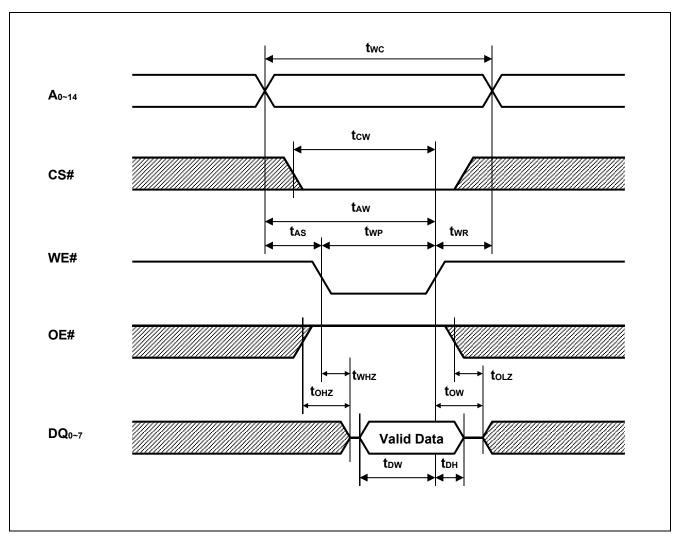
Timing Waveforms

Read Cycle



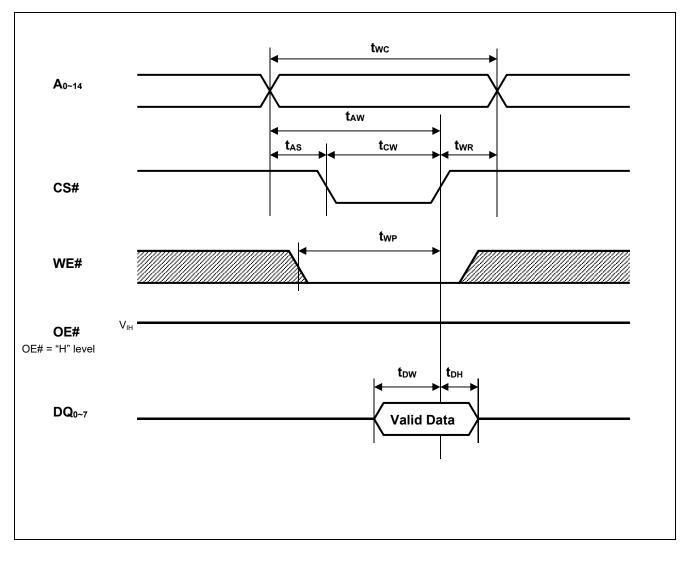


Write Cycle (1) (WE# CLOCK)





Write Cycle (2) (CS# CLOCK)



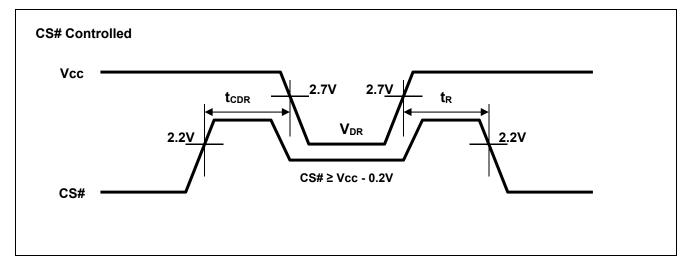


Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions ^{*2}		
V _{CC} for data retention	V _{DR}	2.0	-	3.6	V	Vin ≥ 0V, CS# ≥ Vcc-0.2V		
		-	0.6 ^{*1}	2	μA	~+25°C		
	Iccdr -	-	-	3	μA	~+40°C	Vcc=3.0V, Vin ≥ 0V, CS# ≥ Vcc-0.2V	
Data retention current		-	-	8	μA	~+70°C	CS# 2 VCC-0.2V	
		-	-	10	μA	~+85°C		
Chip deselect time to data retention	t _{CDR}	0	-	-	ns			
Operation recovery time	t _R	5	-	-	ms	See retention waveform.		

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

2. CS# controls address buffer, WE# buffer, OE# buffer and Din buffer. If CS# controls data retention mode, Vin levels (address, WE#, OE#, DQ) can be in the high impedance state.

Low Vcc Data Retention Timing Waveforms





R1LV5256E Series Data Sheet

		Description	
Rev.	Date	Page	Summary
1.00	2017.1.27	-	First Edition issued
2.00	2019.10.29	p.1	Revised orderable part name information.

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